

Loctite® 3440 1 component Gold/polymer filler Anisotropic Epoxy Adhesive

Category : Polymer , Adhesive , Thermoset , Epoxy , Epoxy, Electrically Conductive

Material Notes:

Electrically Conductive Bonding and Encapsulants and Underfills Loctite® Electrically Conductive Adhesives are used in a variety of applications where electrical connectivity is needed, providing a conductive path where traditional methods such as solder, are not practical. Electrically Conductive Adhesives are ideal for attaching temperature sensitive components, or providing electrical interconnections on non-solderable substrates, such as plastic and glass. Loctite offers a complete line of electrically conductive adhesives to meet almost any need including: flexible, heat cure, room temperature cure, screen printable, high adhesion, and rapid cure. COB/DCA Encapsulants are essential to the reliability of flip chip assemblies because they minimize the thermal mismatch between the flip chip and substrate. Loctite® Underfills and Encapsulants improve assembly operations by providing superior reliability and faster throughput. Improved reliability is achieved through products that have a high Tg, low CTE, high throughput and excellent adhesion. Faster throughput and higher yields are achieved through faster flow characteristics and increased cure speeds. Loctite® 3440 1 component Gold/polymer filler Anisotropic Epoxy Adhesive For flex circuit interconnect, TAB interconnection, smart cards, COB, COG. Suitable for LCD assembly. A gold/polymer-filled epoxy for flex circuit interconnect, TAB interconnection, smart cards, COG, and COG. Suitable for LCD assembly. Cure Type: Heat Bonding Type: Epoxy

Order this product through the following link:

http://www.lookpolymers.com/polymer_Loctite-3440-1-component-Goldpolymer-fillerAnisotropic-Epoxy-Adhesive.php

Physical Properties	Metric	English	Comments
Density	1.30 g/cc	0.0470 lb/in ³	

Thermal Properties	Metric	English	Comments
CTE, linear	>= 50.0 µm/m-°C	>= 27.8 µin/in-°F	
	@Temperature 20.0 °C	@Temperature 68.0 °F	
Glass Transition Temp, Tg	120 °C	248 °F	

Processing Properties	Metric	English	Comments
Cure Time	1.00 min	0.0167 hour	60 sec. @ 180°C under 200 psi load
Shelf Life	6.00 Month	6.00 Month	shelf life at 5°C

Contact Songhan Plastic Technology Co.,Ltd.

Website : www.lookpolymers.com

Email : sales@lookpolymers.com

Tel : +86 021-51131842

Mobile : +86 13061808058

Skype : lookpolymers

Address : United North Road 215,Fengxian District, Shanghai City,China